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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/700,177	11/03/2003	Mukesh K. Puri	03-0291	3593	
24319 LSI CORPORA	590 08/28/2008 ΓΙΟΝ		EXAMINER		
1621 BARBER		KERVEROS, JAMES C			
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			2117		
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		Application	No.	Applicant(s)			
Office Action Summary		10/700,177		PURI ET AL.			
		Examiner		Art Unit			
		JAMES C. K	ERVEROS	2117			
The MAILING DATE of Period for Reply	this communication a	appears on the c	over sheet with the o	correspondence a	ddress		
A SHORTENED STATUTOR WHICHEVER IS LONGER, F - Extensions of time may be available u after SIX (6) MONTHS from the mailin - If NO period for reply is specified abov - Failure to reply within the set or extend Any reply received by the Office later t earned patent term adjustment. See 3	ROM THE MAILING noter the provisions of 37 CFR g date of this communication. e, the maximum statutory period period for reply will, by state than three months after the ma	DATE OF THIS 1.136(a). In no event od will apply and will e tute, cause the applica	COMMUNICATION however, may a reply be tir xpire SIX (6) MONTHS from tion to become ABANDONE	N. nely filed the mailing date of this of (35 U.S.C. § 133).			
Status							
Responsive to communication is FINAL. 3) Since this application is closed in accordance visconians.	2b)∏ TI s in condition for allow	his action is nor vance except fo	r formal matters, pro		e merits is		
Disposition of Claims							
4)	s) is/are withd allowed. are rejected. objected to.	rawn from cons					
Application Papers							
9) The specification is objection 10) The drawing(s) filed on Applicant may not request Replacement drawing should be a sho	03 November 2003 is t that any objection to the eet(s) including the corre	s/are: a) ☐ acc he drawing(s) be ection is required	held in abeyance. See if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 C	FR 1.121(d).		
Priority under 35 U.S.C. § 119							
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 							
Attachment(s) 1) Notice of References Cited (PTO-2) Notice of Draftsperson's Patent Dr 3) Information Disclosure Statement(Paper No(s)/Mail Date	awing Review (PTO-948)	_) Interview Summary Paper No(s)/Mail D:) Notice of Informal F) Other:	ate			



Application No.

DETAILED ACTION

This is a FINAL Office Action in response to the Amendment filed 7/15/2008.

Claims 1-18 were rejected in the prior Office Action.

Claim 2 is cancelled. Claims 1 and 3-18 are pending.

New corrected drawings in compliance with 37 CFR 1.121(d) are required in this application because the drawings Fig. 1-3 are informal. Formal drawings may be submitted upon Allowance of the Application.

Rejection of the Claims under 35 U.S.C. 112, second paragraph, has been withdrawn in view of the amendment to the claims.

Response to Arguments

Applicant's arguments filed 7/15/2008 with respect to claims 1-18 have been fully considered but they are not persuasive.

Applicant argues that Zorian neither discloses nor suggests the limitations recited in the independent claims 1 and 12, as currently amended, which now specifically claims "loading a value into an on-chip counter through a test pattern during production testing, where the value represents an amount of redundant elements which are allowed for a repair......, using a repair solution to repair a first set of damaged memories while not repairing and instead flagging a second set of damaged memories, wherein each of the memories in the second set have been determined to require a number of redundant elements to be used for the repair, where the number exceeds the value which has been loaded into the on-chip counter".

In response to Applicant's argument that Zorian fails to disclose the above new limitations, the Examiner wishes to direct Applicant's attention to Zorian, Fig. 8, showing a Built-In Redundancy Analysis (BIRA) engine 802 that determines whether a memory array will be repairable or not repairable, based on the assignment of redundant rows or columns, where the (BIRA) engine 802 allocates the redundant components, such as one or more redundant columns and the one or more redundant rows. In this case for the sake or argument, the repairable feature corresponds to the claimed limitation "a first set of damaged memories", the not repairable feature corresponds to the claimed limitation "a second set of damaged memories", and the status bit registers 810 and 812

corresponds to the claimed limitation of "loading a value into an on-chip counter, where the value represents an amount of redundant elements which are allowed for a repair". The status bit registers 810 and 812 record the status of redundant row registers, and indicate whether the corresponding redundant row is available or unavailable as a substitute row. Similarly, status bit register-CL (not shown) and status bit register-CH (not shown) record the status of redundant column registers. The status bit registers indicate whether the corresponding redundant column is available or unavailable as a substitute column.

The BIRA engine 802 assigns the redundant components determines whether a memory array will be repairable or not repairable, thereby, increasing or decreasing the yield of useable memories on the chip. According to a first Built-In -Redundancy-Analysis algorithm:

First, if at least two faulty cells are encountered, then the row requires repair with a redundant row. If an available redundant row does not exist, then the memory array is considered unrepairable.

Second, if a single faulty cell is encountered, then a redundant column is used for repair, if available. If no spare column is available but a spare row is available, then a redundant row is used for repair. Otherwise, the memory array is considered unrepairable.

Therefore, the limitation "flagging a second set of damaged memories" corresponds to not repairable memory array feature, since the failed memory array requires extensive repair.

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Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1 and 3-18 are rejected under 35 U.S.C. 102(e) as being anticipated by Zorian (US 7,237,154) filed: February 25, 2002.

Regarding independent Claims 1, 12, Zorian discloses a method and apparatus that generate an augmented repair signature to repair all of the defects detected in a first test of a memory as well as in a second test of the memory, comprising:

Testing the memories a first time; "A first test of the memory occurs and a first redundancy allocation algorithm 232 is run. The redundancy allocation algorithm identifies defects and then allocates redundant components to replace those identified defects", Fig. 2b.

Generating a repair solution; "The reconfiguration logic collects data from the results of the redundancy allocation algorithm to generate a first repair signature 234. The first test and/or the repair algorithms may be performed by logic on the chip or by test equipment external to the chip".

Using the repair solution (first repair signature 234) to repair the memories while flagging those memories whose repair exceeds a pre-determined limit; "The repair signature (234) includes a coded sequence to allocate redundant components to substitute for defective components in order to make the memory usable. The coded sequence loads into registers associated with the redundancy allocation logic to replace all of the identified defective components with redundant components".

Making an on-chip assessment to test the memories a second time; "A quality assurance built in self-test 236 runs to determine that all defects in the memory have been eliminated through the use of redundant components and that the assigned redundant components have no defects".

Using the repair solution (234) to repair the memories not previously flagged; "The configuration logic in the processor may receive the existing first repair signature 234 from a storage device external to the chip or from the fuse box. When the reconfiguration logic receives the first repair signature 234, the reconfiguration logic may initiate a second test algorithm and second redundancy allocation algorithm 238 to attempt to repair the memory. The test logic provides the results of the second test, thus all known and identified defects, to the redundancy algorithm to repair all of the defects in the memory. The reconfiguration logic then generates a second repair signature 240. After the redundancy allocation logic assigns the corresponding redundant components to replace identified defective components, then a quality assurance built in self test of the memory 236 runs one more time just to make sure that the redundant components substituted for the defective components, also do not have defects".

Also, as shown in Fig. 3, the BIRA engine 308 (Built-in Redundancy Allocation) identifies and allocates available redundant rows and redundant columns in order to determine the optimum redundancy scheme when a failure occurs. Also, Fig. 4 shows available redundancy 404, which corresponds to "loading a value into an on-chip counter through a test pattern during production testing, where the value represents an amount of redundant elements which are allowed for a repair".

Regarding Claims 3-11, 13-18, Zorian discloses, with respect to claimed limitation of loading a counter with values to establish a threshold for pass/fail criteria, Built-In Redundancy Analysis (BIRA) engine 802, Figs. 8, having a plurality of registers for allocating redundant columns and rows. The registers (804) store information for final self-repair. If the memory is diagnosed as repairable the final contents of the registers contain the addresses of rows and columns to be replaced with the corresponding spare elements. The BIRA engine 802 determines whether a memory array will be repairable or not repairable, based on the assignment of redundant rows or columns.

If at least two faulty cells are encountered in a word either in the lower bank or the upper bank of the memory array, then the row requires repair with a redundant row. If an available redundant row does not exist, then the memory array is considered not repairable.

If a single faulty cell is encountered in a word either in the lower bank or the upper bank of the memory array then a redundant column is used for repair, if available.

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If no spare column is available but a spare row is available, then a redundant row is used for repair. Otherwise, the memory array is considered not repairable.

In this case, the pre-determined limit corresponds to the number of spare rows or columns, where the pre-determined limit is used as a criterion to determine whether a memory array is repairable or not repairable, as described previously.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to JAMES C. KERVEROS whose telephone number is (571) 272-3824. The examiner can normally be reached on 9:00 AM TO 5:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Jacques H. Louis-Jacques can be reached on (571) 272-4150. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/JAMES C KERVEROS/ Primary Examiner, Art Unit 2117

Date: 8 September 2008
Office Action: Final Rejection

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